# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Ultra low-dropout regulator, low noise, 200 mA

Rev. 3 — 9 December 2011

**Product data sheet** 

## 1. Product profile

## 1.1 General description

The LD6806 series is a small-size Low-DropOut regulator (LDO) family with a typical voltage drop of 60 mV at 200 mA current rating.

The device is available in three different surface-mounted packages, one 0.4 mm pitch CSP, one leadless plastic package SOT886 and one gull wing package SOT753.

The operating voltage ranges from 2.3 V to 5.5 V and the output voltage ranges from 1.2 V to 3.6 V.

LD6806x/xxH devices show a high-ohmic state at the output pin, while the LD6806x/xxP contains a pull-down switching transistor, to provide a low-ohmic output stage when the device is disabled. All devices use the same regulator design and are manufactured in monolithic silicon technology.

These features make the LD6806 series ideal for use in applications requiring component miniaturization, such as mobile phone handsets, cordless telephones and personal digital devices.

### 1.2 Features and benefits

- Input voltage range 2.3 V to 5.5 V
- Output voltage range 1.2 V to 3.6 V
- Dropout voltage 60 mV at 200 mA output rating
- Low quiescent current in shutdown mode (typical 1.0 μA)
- 30 μV RMS output noise voltage (typical value) at 10 Hz to 100 kHz
- Turn-on time just 200 μs
- 55 dB Power Supply Rejection Ratio (PSRR) at 1 kHz
- Temperature watchdog
- Current limiter
- LD6806xxxH: high-ohmic (3-state) output state when disabled
- LD6806xxxP: low-ohmic output state when disabled
- Integrated ESD protection of 10 kV Human Body Model
- WLCSP with 0.4 mm pitch and package size of 0.76 mm × 0.76 mm × 0.47 mm
- SOT886 leadless package 1.0 mm × 1.45 mm × 0.5 mm
- SOT753 plastic surface-mounted device
- Pb-free, RoHS compliant and free of Halogen and Antimony (dark green compliant)



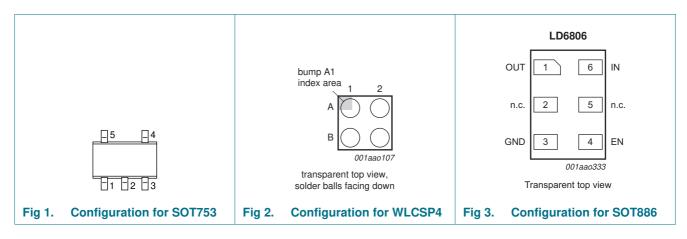
#### Ultra low-dropout regulator, low noise, 200 mA

### **1.3 Applications**

Analog and digital interfaces requiring lower than standard supply voltage in mobile appliances such as mobile phones, media players and so on.

## 2. Pinning information

### 2.1 Pinning



### 2.2 Pin description

#### Table 1. Pin description for SOT753

| Symbol | Pin | Description                      |
|--------|-----|----------------------------------|
| IN     | 1   | supply voltage input             |
| GND    | 2   | supply ground                    |
| EN     | 3   | device enable input; active HIGH |
| n.c.   | 4   | not connected                    |
| OUT    | 5   | regulator output voltage         |

#### Table 2. Pin description for WLCSP4

| Symbol | Pin | Description                      |
|--------|-----|----------------------------------|
| GND    | A1  | supply ground                    |
| EN     | A2  | device enable input; active HIGH |
| OUT    | B1  | regulator output voltage         |
| IN     | B2  | supply voltage input             |

#### Table 3.Pin description for SOT886

| Symbol | Pin | Description              |
|--------|-----|--------------------------|
| OUT    | 1   | regulator output voltage |
| n.c.   | 2   | not connected            |
| GND    | 3   | supply ground            |

#### Ultra low-dropout regulator, low noise, 200 mA

| Table 3. | Pin description for SOT886 |                                  |  |
|----------|----------------------------|----------------------------------|--|
| Symbol   | Pin Description            |                                  |  |
| EN       | 4                          | device enable input; active HIGH |  |
| n.c.     | 5                          | not connected                    |  |
| IN       | 6                          | supply voltage input             |  |

#### **Ordering information** 3.

| Type number     | Package |   |         |
|-----------------|---------|---|---------|
|                 | Name    | Description   | Version |
| LD6806CX4/xxx   | WLCSP4  | wafer level chip-size package; 4 bumps $(2 \times 2)^{[1]}$   | -       |
| LD6806CX4/C/xxx | WLCSP4  | wafer level chip-size package; 4 bumps $(2 \times 2)$ with backside coating <sup>[1]</sup>              | -       |
| D6806F/xxx      | XSON6   | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm | SOT886  |
| _D6806TD/xxx    | TSOP5   | plastic surface-mounted package; 5 leads  | SOT753  |

[1] Size 0.76 mm  $\times$  0.76 mm.

### 3.1 Ordering options

Further information on output voltage is available on request; see Section 21 "Contact information".

#### Type number and nominal output voltage of high-ohmic output Table 5.

| Type number                   | Nominal<br>output<br>voltage | Type number                   | Nominal<br>output<br>voltage |
|-------------------------------|------------------------------|-------------------------------|------------------------------|
| LD6806[CX4, CX4/C, F, TD]/12H | 1.2 V                        | LD6806[CX4, CX4/C, F, TD]/23H | 2.3 V                        |
| LD6806[CX4, CX4/C, F, TD]/13H | 1.3 V                        | LD6806[CX4, CX4/C, F, TD]/25H | 2.5 V                        |
| LD6806[CX4, CX4/C, F, TD]/14H | 1.4 V                        | LD6806[CX4, CX4/C, F, TD]/28H | 2.8 V                        |
| LD6806[CX4, CX4/C, F, TD]/16H | 1.6 V                        | LD6806[CX4, CX4/C, F, TD]/29H | 2.9 V                        |
| LD6806[CX4, CX4/C, F, TD]/18H | 1.8 V                        | LD6806[CX4, CX4/C, F, TD]/30H | 3.0 V                        |
| LD6806[CX4, CX4/C, F, TD]/20H | 2.0 V                        | LD6806[CX4, CX4/C, F, TD]/33H | 3.3 V                        |
| LD6806[CX4, CX4/C, F, TD]/22H | 2.2 V                        | LD6806[CX4, CX4/C, F, TD]/36H | 3.6 V                        |

#### Table 6. Type number and nominal output voltage of low.ohmic output

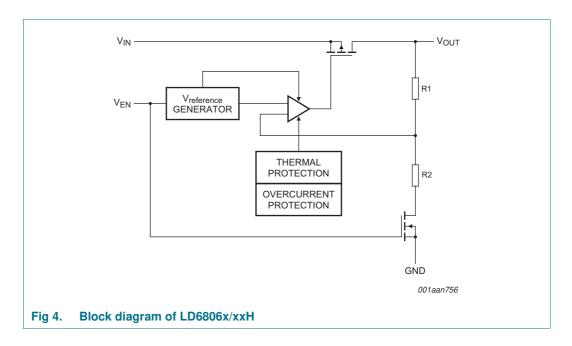
| Type number                   | Nominal<br>output<br>voltage | Type number                   | Nominal<br>output<br>voltage |
|-------------------------------|------------------------------|-------------------------------|------------------------------|
| LD6806[CX4, CX4/C, F, TD]/12P | 1.2 V                        | LD6806[CX4, CX4/C, F, TD]/23P | 2.3 V                        |
| LD6806[CX4, CX4/C, F, TD]/13P | 1.3 V                        | LD6806[CX4, CX4/C, F, TD]/25P | 2.5 V                        |
| LD6806[CX4, CX4/C, F, TD]/14P | 1.4 V                        | LD6806[CX4, CX4/C, F, TD]/28P | 2.8 V                        |
| LD6806[CX4, CX4/C, F, TD]/16P | 1.6 V                        | LD6806[CX4, CX4/C, F, TD]/29P | 2.9 V                        |

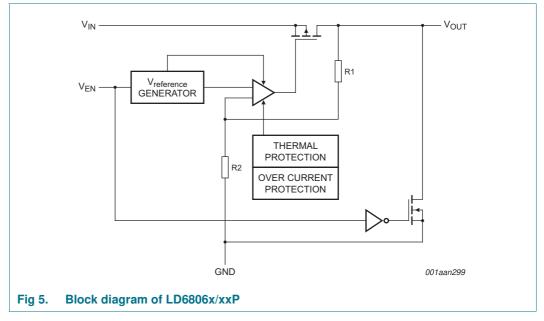
### Ultra low-dropout regulator, low noise, 200 mA

 Table 6.
 Type number and nominal output voltage of low.ohmic output ...continued

| Type number                   | Nominal<br>output<br>voltage | Type number                   | Nominal<br>output<br>voltage |
|-------------------------------|------------------------------|-------------------------------|------------------------------|
| LD6806[CX4, CX4/C, F, TD]/18P | 1.8 V                        | LD6806[CX4, CX4/C, F, TD]/30P | 3.0 V                        |
| LD6806[CX4, CX4/C, F, TD]/20P | 2.0 V                        | LD6806[CX4, CX4/C, F, TD]/33P | 3.3 V                        |
| LD6806[CX4, CX4/C, F, TD]/22P | 2.2 V                        | LD6806[CX4, CX4/C, F, TD]/36P | 3.6 V                        |

## 4. Block diagram





shoot

Ultra low-dropout regulator, low noise, 200 mA

## 5. Limiting values

#### Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

|                  |                                 |                                  |              |      | ,    |
|------------------|---------------------------------|----------------------------------|--------------|------|------|
| Symbol           | Parameter                       | Conditions                       | Min          | Max  | Unit |
| V <sub>IN</sub>  | voltage on pin IN               | 4 ms transient                   | -0.5         | +6.0 | V    |
| P <sub>tot</sub> | total power dissipation         | LD6806CX4/xxx,<br>LD6806CX4/Cxxx | <u>[1]</u> - | 770  | mW   |
|                  |                                 | LD6806F/xxx                      | [1] -        | 450  | mW   |
|                  |                                 | LD6806TD/xxx                     | [1] -        | 800  | mW   |
| T <sub>stg</sub> | storage temperature             |                                  | -55          | +150 | °C   |
| Tj               | junction temperature            |                                  | -40          | +125 | °C   |
| T <sub>amb</sub> | ambient temperature             |                                  | -40          | +85  | °C   |
| $V_{ESD}$        | electrostatic discharge voltage | human body model level 6         | [2]          | ±10  | kV   |
|                  |                                 | machine model class 3            | [3] _        | ±400 | V    |
|                  |                                 |                                  |              |      |      |

[1] The (absolute) maximum power dissipation depends on the junction temperature T<sub>j</sub>. Higher power dissipation is allowed with lower ambient temperatures. The conditions to determine the specified values are T<sub>amb</sub> = 25 °C and the use of a two layer PCB.

[2] According to IEC 61340-3-1.

[3] According to JESD22-A115C.

## 6. Recommended operating conditions

#### Table 8.Operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                 | Conditions | Min            | Max             | Unit |
|---------------------|---------------------------|------------|----------------|-----------------|------|
| T <sub>amb</sub>    | ambient temperature       |            | -40            | +85             | °C   |
| Tj                  | junction temperature      |            | -              | +125            | °C   |
| Pin IN              |                           |            |                |                 |      |
| V <sub>IN</sub>     | voltage on pin IN         |            | 2.3            | 5.5             | V    |
| Pin EN              |                           |            |                |                 |      |
| $V_{\text{EN}}$     | voltage on pin EN         |            | 0              | V <sub>IN</sub> | V    |
| Pin OUT             |                           |            |                |                 |      |
| C <sub>L(ext)</sub> | external load capacitance |            | <u>[1]</u> 1.0 | -               | μF   |

[1] See Section 10.1 "Output capacitor values".

#### Ultra low-dropout regulator, low noise, 200 mA

## 7. Thermal characteristics

| Table 9.             | Thermal characteristics                     |                                  |                    |      |
|----------------------|---|----------------------------------|--------------------|------|
| Symbol               | Parameter                                   | Conditions                       | Тур                | Unit |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | LD6806CX4/xxx,<br>LD6806CX4/Cxxx | <u>[1][2]</u> 130  | K/W  |
|                      |   | LD6806F/xxx                      | [1][2] 220         | K/W  |
|                      |   | LD6806TD/xxx                     | [ <u>1][2]</u> 125 | K/W  |

[1] The overall R<sub>th(j-a)</sub> can vary depending on the board layout. To minimize the effective R<sub>th(j-a)</sub>, all pins must have a solid connection to larger Cu layer areas for example to the power and ground layer. In multi-layer PCB applications, the second layer should be used to create a large heat spreader area directly below the LDO. If this layer is either ground or power, it should be connected with several vias to the top layer connecting to the device ground or supply. Avoid the use of solder-stop varnish under the chip.

[2] Use the measurement data given for a rough estimation of the R<sub>th(j-a)</sub> in your application. The actual R<sub>th(j-a)</sub> value can vary in applications using different layer stacks and layouts.

## 8. Characteristics

#### Table 10. Electrical characteristics

At recommended input voltages and  $T_{amb} = -40$  °C to +85 °C; voltages are referenced to GND (ground = 0 V); unless otherwise specified.

| Symbol                                | Parameter   | Conditions                                      |            | Min  | Тур    | Max  | Unit         |
|---------------------------------------|---|---|------------|------|--------|------|--------------|
| ΔV <sub>O</sub>                       | output voltage variation                                | $V_{OUT}$ < 1.8 V; $I_{OUT}$ = 1 mA             |            |      |        |      |              |
|                                       |   | T <sub>amb</sub> = +25 °C                       |            | -3   | ±0.5   | +3   | %            |
|                                       |   | $-30~^\circ C \le T_{amb} \le +85~^\circ C$     |            | -4   | -      | +4   | %            |
|                                       |   | $V_{OUT} \geq 1.8 \ V; \ I_{OUT} = 1 \ mA$      |            |      |        |      |              |
|                                       |   | $T_{amb} = +25 \ ^{\circ}C$                     |            | -2   | ±0.5   | +2   | %            |
|                                       |   | $-30~^{\circ}C \leq T_{amb} \leq +85~^{\circ}C$ |            | -3   | -      | +3   | %            |
| Line regulation                       | n error   |   |            |      |        |      |              |
| $\Delta V_{O}/(V_{O} x \Delta V_{I})$ | relative output voltage<br>variation with input voltage | $V_{\text{IN}}$ = (V_{O(nom)} + 0.2 V) to 5.5 V | [1]        | -0.1 | -      | +0.1 | %/V          |
| Load regulatio                        | on error  |   |            |      |        |      |              |
| $\Delta V_{O}/(V_{O}x\Delta I_{O})$   | relative output voltage variation with output current   | $1~mA \leq I_{OUT} \leq 200~mA$                 |            |      |        |      |              |
|                                       |   | LD6806CX4/xxx, LD6806CX4/Cxxx                   |            | -    | 0.0025 | 0.01 | %/mA         |
|                                       |   | LD6806F/xxx, LD6806TD/xxx                       |            | -    | 0.005  | 0.02 | %/m <b>A</b> |
| V <sub>do</sub>                       | dropout voltage   | $I_{OUT}$ = 200 mA; $V_{IN} > V_{O(nom)}$       | [1]        |      |        |      |              |
|                                       |   | LD6806CX4/xxx, LD6806CX4/Cxxx                   |            | -    | 60     | 100  | mV           |
|                                       |   | LD6806F/xxx, LD6806TD/xxx                       |            | -    | 80     | 130  | mV           |
| V <sub>IL</sub>                       | LOW-level input voltage                                 | pin EN  |            | 0    | -      | 0.4  | V            |
| V <sub>IH</sub>                       | HIGH-level input voltage                                | pin EN  |            | 1.4  | -      | 5.5  | V            |
| I <sub>OUT</sub>                      | current on pin OUT                                      |   |            | -    | -      | 200  | mA           |
| I <sub>OM</sub>                       | peak output current                                     | $V_{\text{IN}}$ = (V_{O(nom)} + 0.2 V) to 5.5 V | <u>[1]</u> |      |        |      |              |
|                                       |   | V <sub>O(nom)</sub> > 1.8 V;                    |            | 300  | -      | -    | mA           |
|                                       |   | $V_{OUT}=0.95 \times V_{O(nom)}$                |            |      |        |      |              |
|                                       |   | V <sub>O(nom)</sub> < 1.8 V;                    |            | 300  | -      | -    | mA           |
|                                       |   | $V_{OUT} = 0.9 \times V_{O(nom)}$               |            |      |        |      |              |

6 of 36

### Ultra low-dropout regulator, low noise, 200 mA

#### Table 10. Electrical characteristics ... continued

At recommended input voltages and  $T_{amb} = -40$  °C to +85 °C; voltages are referenced to GND (ground = 0 V); unless otherwise specified.

| Symbol                    | Parameter                          | Conditions  | Min          | Тур | Max | Unit |
|---------------------------|------------------------------------|---|--------------|-----|-----|------|
| I <sub>sc</sub>           | short-circuit current              | pin OUT   | -            | 600 | -   | mA   |
| lq                        | quiescent current                  | $V_{EN} = 1.4 \text{ V}; I_{OUT} = 0 \text{ mA}$  | -            | 70  | 100 | μA   |
|                           |                                    | $V_{EN}$ = 1.4 V; 1 mA $\leq$ $I_{OUT} \leq$ 200 mA   | -            | 155 | 250 | μA   |
|                           |                                    | $V_{EN} \le 0.4 V$  | -            | 0.1 | 1.0 | μA   |
| T <sub>sd</sub>           | shutdown temperature               |   | -            | 160 | -   | °C   |
| T <sub>sd(hys)</sub>      | shutdown temperature<br>hysteresis |   | [2] _        | 20  | -   | °K   |
| PSRR                      | power supply rejection ratio       | $\label{eq:VIN} \begin{array}{l} V_{IN} = V_{O(nom)} + 1 \ V; \ I_{OUT} = 30 \ mA; \\ f_{ripple} = 1 \ kHz \end{array}$ | [1] -        | -55 | -   | dB   |
| V <sub>n(o)(RMS)</sub>    | RMS output noise voltage           | bandwidth = 10 Hz to 100 kHz; $C_{L(ext)} = 1 \ \mu F$  | -            | 30  | -   | μV   |
| t <sub>startup(reg)</sub> | regulator start-up time            |   | <u>[1]</u> _ | -   | 200 | μS   |
| t <sub>sd(reg)</sub>      | regulator shutdown time            | $V_{IN}$ = 5.5 V; $C_{L(ext)}$ = 1 $\mu$ F  | <u>[3]</u> _ | 300 | -   | μS   |
| R <sub>pd</sub>           | pull-down resistance               |   | <u>[3]</u> _ | 100 | -   | Ω    |

[1]  $V_{O(nom)}$  = nominal output voltage (device specific).

[2] The junction temperature must decrease by  $T_{sd(hys)}$  to enable the device after  $T_{sd}$  was reached and the device was disabled.

[3] LD6806x/xxP only.

## 9. Dynamic behavior

All results described in <u>Section 9</u> are based on measurements of types LD6806CX4xxx and LD6806Fxxx from the LD6806 product series within <u>Section 6 "Recommended</u> operating conditions".

#### 9.1 Dropout

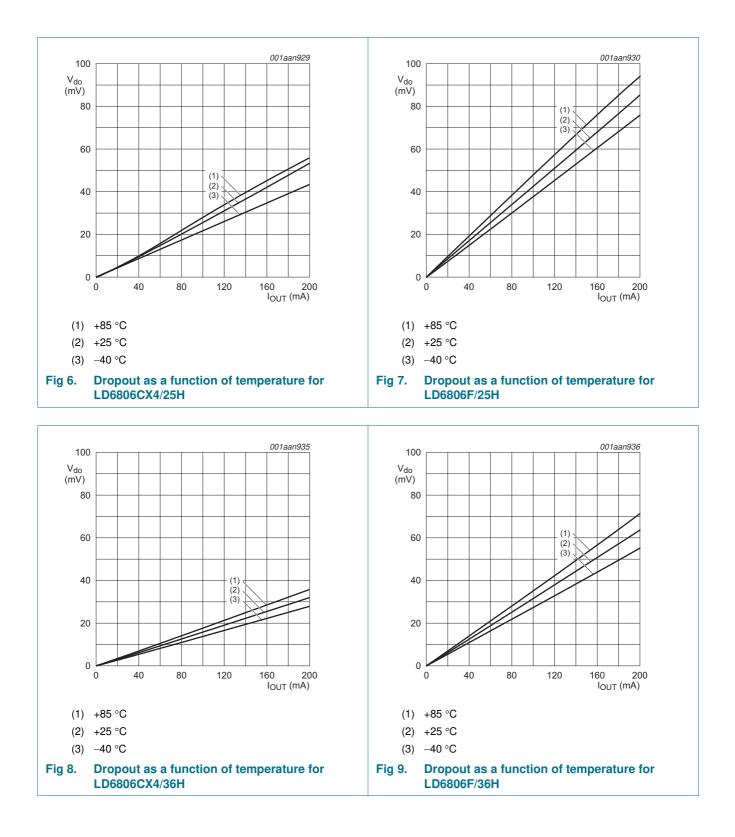
The dropout voltage is defined as the smallest input to output voltage difference at a specified load current when the regulator operates within its linear region with the pass transistor functioning as a plain resistor. This means that the input voltage is below the nominal output voltage value.

A small dropout voltage guaranties lower power consumption and efficiency maximization.

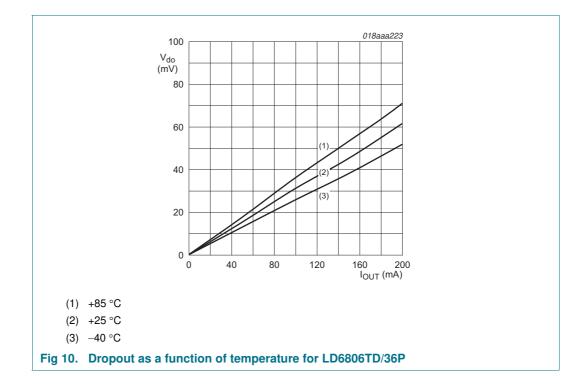
### **NXP Semiconductors**

## LD6806 series

#### Ultra low-dropout regulator, low noise, 200 mA

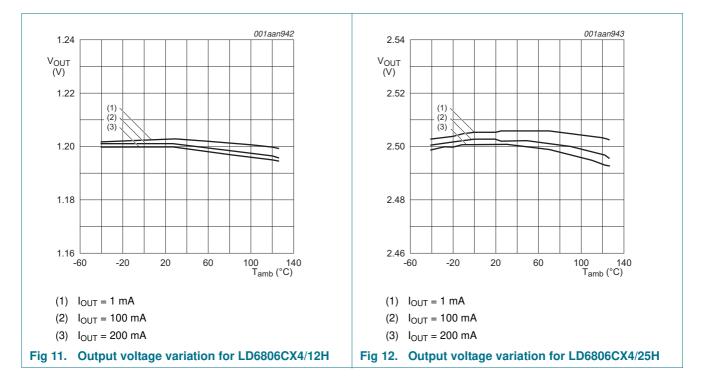


#### Ultra low-dropout regulator, low noise, 200 mA



## 9.2 Output voltage variation

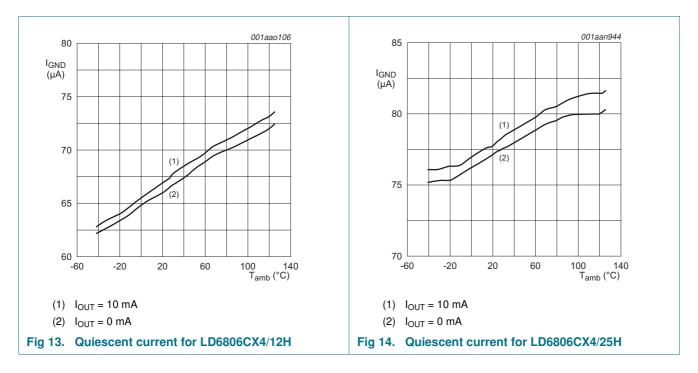
The guaranteed output voltages are specified in Table 10.



Ultra low-dropout regulator, low noise, 200 mA

### 9.3 Quiescent current

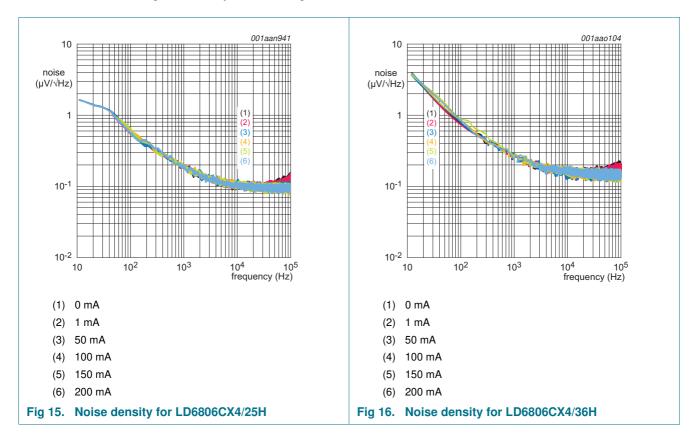
Quiescent or ground current is the difference between the input and the output current of the regulator.



#### Ultra low-dropout regulator, low noise, 200 mA

### 9.4 Noise

Output noise voltage of an LDO circuit is given as noise density or RMS output noise voltage over a defined range of frequencies (10 Hz to 100 kHz). Permanent conditions are a constant output current and a ripple-free input voltage. The output noise voltage is generated by the LDO regulator.

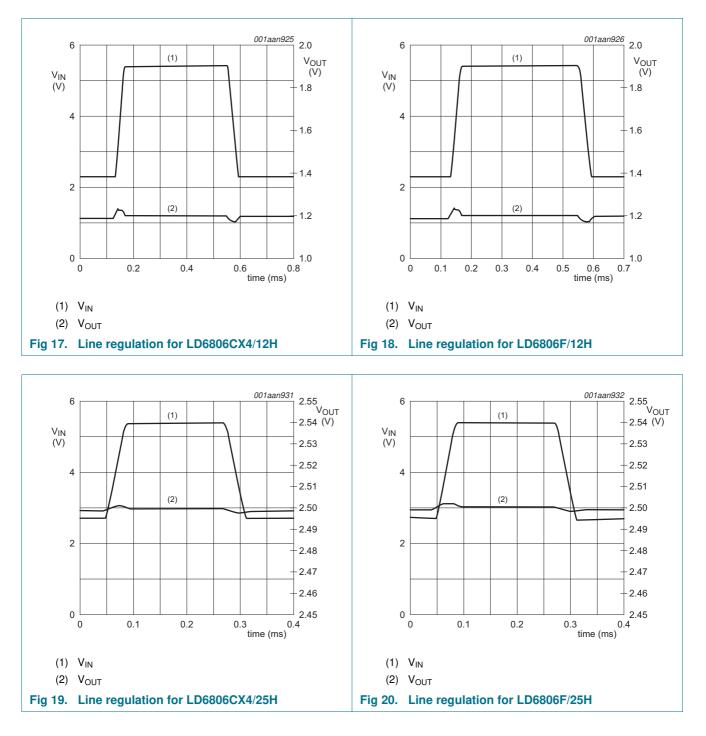


Ultra low-dropout regulator, low noise, 200 mA

## 9.5 Line regulation

Line regulation response is the capability of the circuit to maintain the nominal output voltage while varying the input voltage.

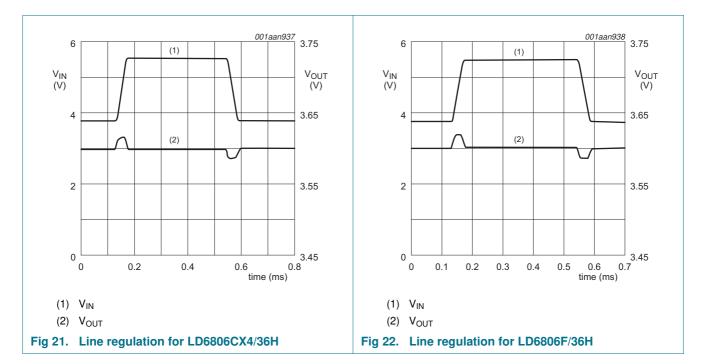
$$Regulation[\%/V] = \frac{\Delta V_{OUT}}{\Delta V_{IN}} \times \frac{100}{V_{OUT}}$$



### **NXP Semiconductors**

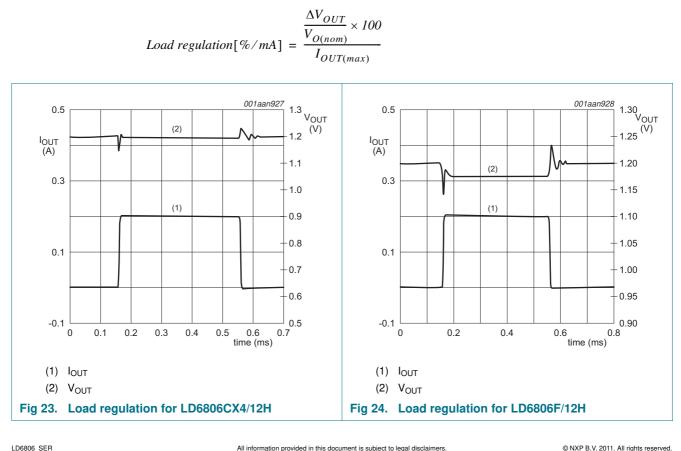
## LD6806 series

Ultra low-dropout regulator, low noise, 200 mA



### 9.6 Load regulation

Load regulation is the capability of the circuit to maintain the nominal output voltage while varying the output load current.

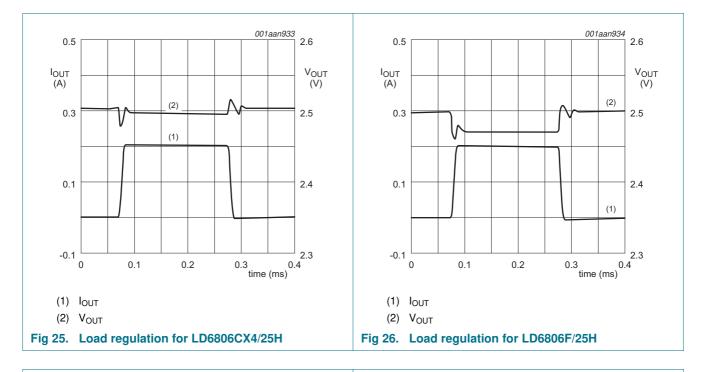


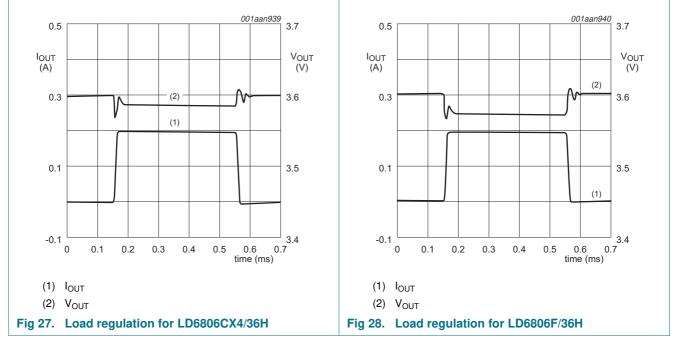
All information provided in this document is subject to legal disclaimers.

### **NXP Semiconductors**

## LD6806 series

### Ultra low-dropout regulator, low noise, 200 mA



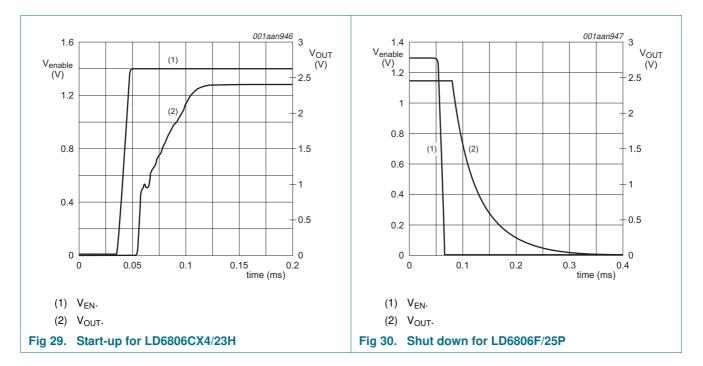


Ultra low-dropout regulator, low noise, 200 mA

### 9.7 Start-up and shut down

Start-up time defines the time needed for the LDO to achieve 95 % of its typical output voltage level after activation via the enable pin.

Shut down time defines the time needed for the LDO to pull-down the output voltage to 10% of its nominal output voltage after deactivation via the enable pin.

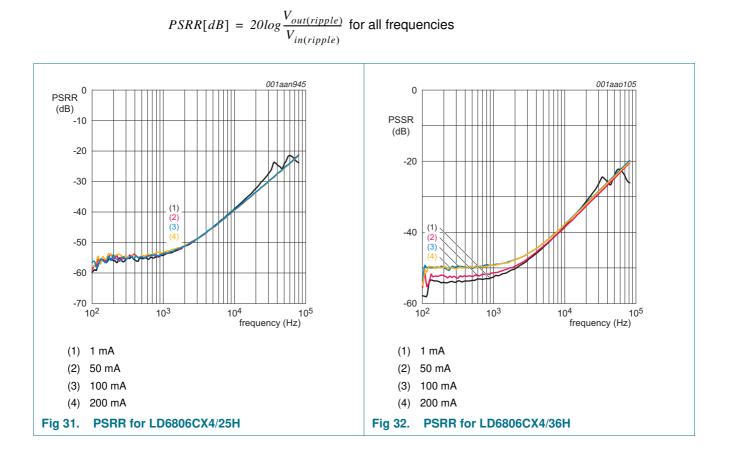


LD6806 SER

Ultra low-dropout regulator, low noise, 200 mA

## 9.8 Power Supply Rejection Ratio (PSRR)

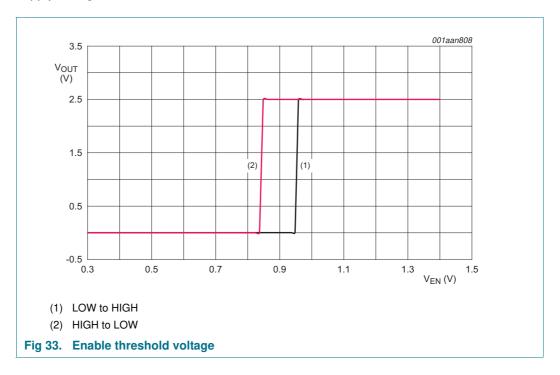
PSRR stands for the capability of the regulator to suppress unwanted signals on the input voltage like noise or ripples.



Ultra low-dropout regulator, low noise, 200 mA

### 9.9 Enable threshold voltage

An active HIGH signal enables the LDO when the signal exceeds the minimum input HIGH voltage threshold. The device is in Off state as long the signal is below the maximum LOW threshold. The input voltage threshold is independent from the LDO supply voltage.



LD6806\_SER

Ultra low-dropout regulator, low noise, 200 mA

## **10. Application information**

### 10.1 Output capacitor values

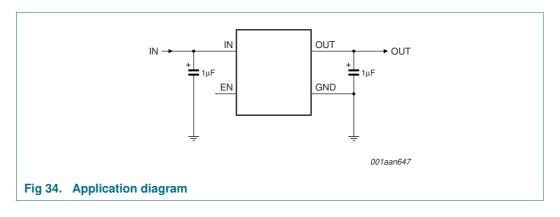
The LD6806 series requires external capacitors at the output to guarantee a stable regulator behavior. Also an input capacitor is recommended to keep the input voltage stable. These capacitors should not under-run the specified minimum Equivalent Series Resistance (ESR).

The absolute value of the total capacitance attached to the output pin OUT influences the shutdown time  $(t_{sd(reg)})$  of the LD6806 series.

| Table 11. | External | load | capacitor |
|-----------|----------|------|-----------|
|           | External | .ouu | oupuonoi  |

| Symbol              | Parameter                    | Conditions | Min   | Тур | Max | Unit |
|---------------------|------------------------------|------------|-------|-----|-----|------|
| C <sub>L(ext)</sub> | external load capacitance    |            | [1] - | 1.0 | -   | μF   |
| ESR                 | equivalent series resistance |            | 5     | -   | 500 | mΩ   |

[1] The minimum value of capacitance for stability and correct operation is 0.7  $\mu$ F. The capacitor tolerance should be ±30 % or better over the temperature range. The full range of operating conditions for the capacitor in the application should be considered during device selection to ensure that this minimum capacitance specification is met. The recommended capacitor type is X7R to meet the full device temperature specification of -40 °C to +125 °C.



## **11. Test information**

### 11.1 Quality information

This product has been qualified in accordance with *NX2-00001 NXP Semiconductors Quality and Reliability Specification* and is suitable for use in consumer applications.

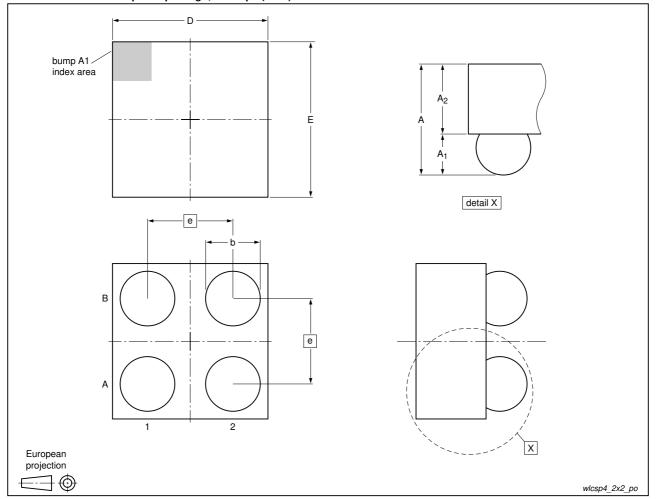
LD6806 SER

### **NXP Semiconductors**

## LD6806 series

Ultra low-dropout regulator, low noise, 200 mA

## 12. Package outline



WLCSP4: wafer level chip-size package; 4 bumps (2 x 2)

### Fig 35. Package outline WLCSP4

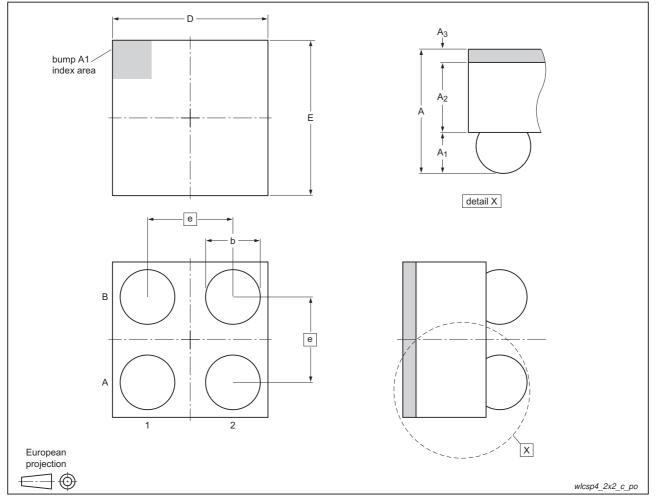
#### Table 12. Dimensions of LD6806CX4/xxx for package outline WLCSP4; see Figure 35

| Symbol         | Min  | Тур  | Max  | Unit |  |
|----------------|------|------|------|------|--|
| Α              | 0.44 | 0.47 | 0.50 | mm   |  |
| A <sub>1</sub> | 0.18 | 0.20 | 0.22 | mm   |  |
| A <sub>2</sub> | 0.26 | 0.27 | 0.28 | mm   |  |
| b              | 0.21 | 0.26 | 0.31 | mm   |  |
| D              | 0.71 | 0.76 | 0.81 | mm   |  |
| E              | 0.71 | 0.76 | 0.81 | mm   |  |
| е              | -    | 0.4  | -    | mm   |  |
|                |      |      |      |      |  |

## **NXP Semiconductors**

## LD6806 series

Ultra low-dropout regulator, low noise, 200 mA



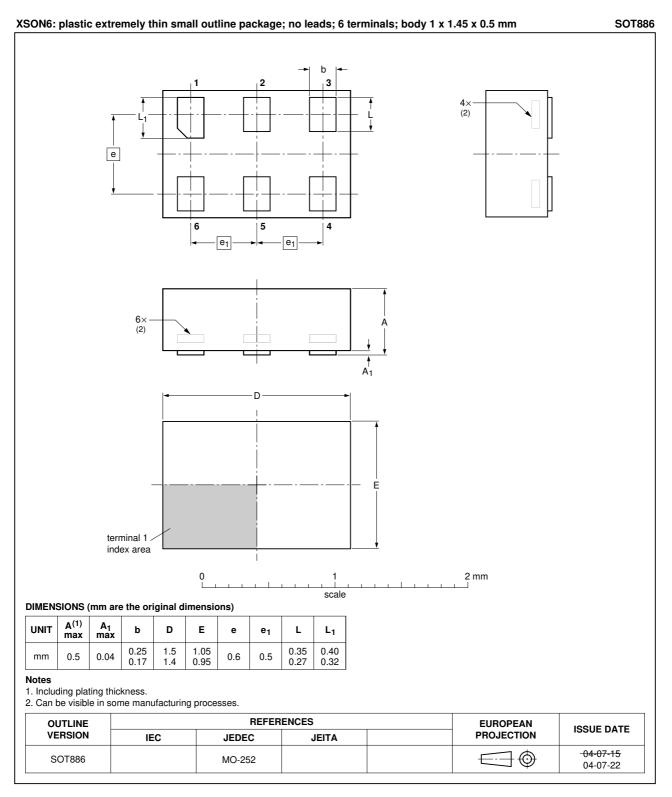
#### WLCSP4: wafer level chip-size package with backside coating; 4 bumps (2 x 2)

### Fig 36. Package outline WLCSP4 with backside coating

#### Table 13. Dimensions of LD6806CX4/Cxxx for package outline WLCSP4 with backside coating; see Figure 36

|                |      |      |      | <u> </u> |
|----------------|------|------|------|----------|
| Symbol         | Min  | Тур  | Max  | Unit     |
| А              | 0.47 | 0.51 | 0.55 | mm       |
| A <sub>1</sub> | 0.18 | 0.20 | 0.22 | mm       |
| A <sub>2</sub> | 0.26 | 0.27 | 0.28 | mm       |
| A <sub>3</sub> | 0.03 | 0.04 | 0.05 | mm       |
| b              | 0.21 | 0.26 | 0.31 | mm       |
| D              | 0.71 | 0.76 | 0.81 | mm       |
| E              | 0.71 | 0.76 | 0.81 | mm       |
| е              | -    | 0.4  | -    | mm       |
|                |      |      |      |          |

Ultra low-dropout regulator, low noise, 200 mA



### Fig 37. Package outline SOT886 (XSON6)

All information provided in this document is subject to legal disclaimers.

Ultra low-dropout regulator, low noise, 200 mA

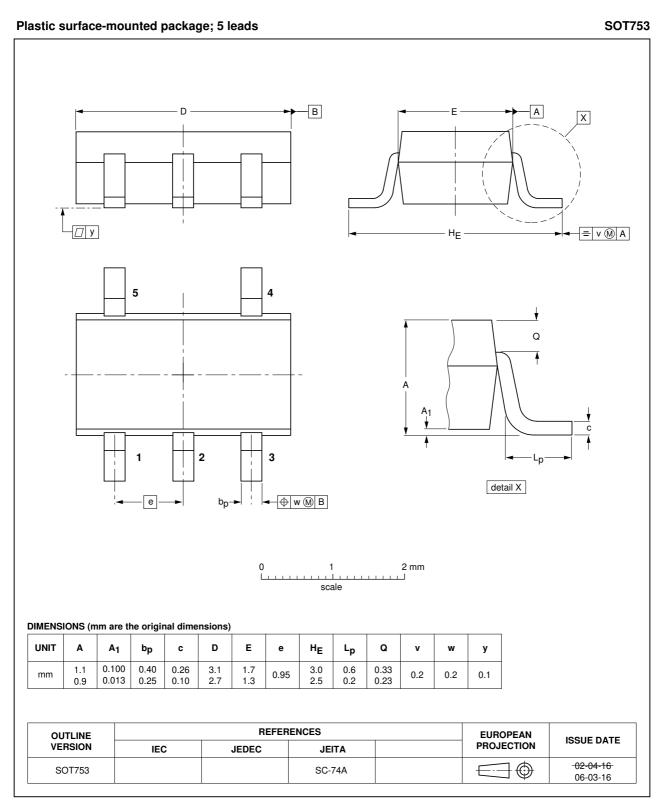
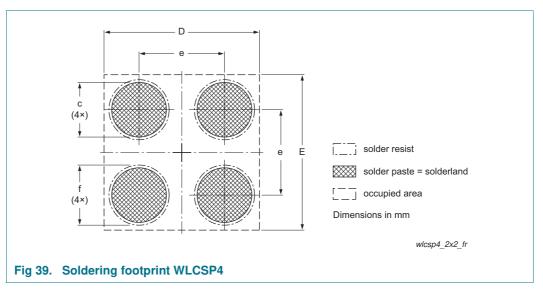


Fig 38. SOT753; Plastic surface-mounted package; 5 leads

All information provided in this document is subject to legal disclaimers.

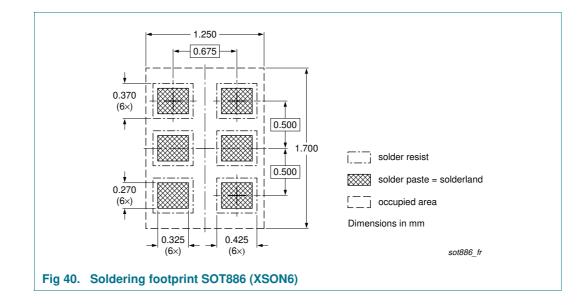
Ultra low-dropout regulator, low noise, 200 mA

## 13. Soldering

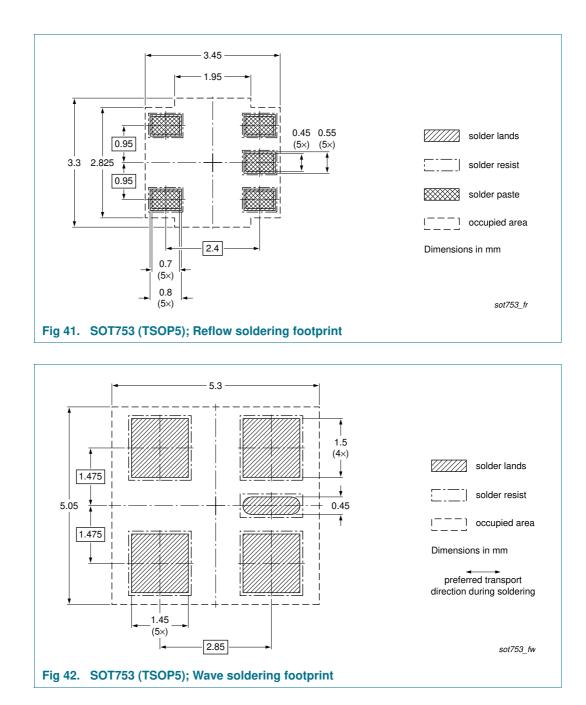


#### Table 14. Dimensions of soldering footprint WLCSP4; see Figure 39

| Symbol | Min  | Тур   | Max  | Unit |
|--------|------|-------|------|------|
| С      | -    | 0.25  | -    | mm   |
| D      | 0.71 | 0.76  | 0.81 | mm   |
| E      | 0.71 | 0.76  | 0.81 | mm   |
| е      | -    | 0.4   | -    | mm   |
| f      | -    | 0.325 | -    | mm   |



Ultra low-dropout regulator, low noise, 200 mA



## 14. Soldering of WLCSP packages

### 14.1 Introduction to soldering WLCSP packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering WLCSP (Wafer Level Chip-Size Packages) can be found in application note *AN10439 "Wafer Level Chip Scale Package"* and in application note *AN10365 "Surface mount reflow soldering description"*.

Wave soldering is not suitable for this package.

All information provided in this document is subject to legal disclaimers.

LD6806 SER

24 of 36

Ultra low-dropout regulator, low noise, 200 mA

All NXP WLCSP packages are lead-free.

### 14.2 Board mounting

Board mounting of a WLCSP requires several steps:

- 1. Solder paste printing on the PCB
- 2. Component placement with a pick and place machine
- 3. The reflow soldering itself

### 14.3 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 43</u>) than a PbSn process, thus reducing the process window
- Solder paste printing issues, such as smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature), and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic) while being low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 15.

| Package thickness (mm) | Package reflow temperature (°C) |             |        |  |  |
|------------------------|---------------------------------|-------------|--------|--|--|
|                        | Volume (mm <sup>3</sup> )       |             |        |  |  |
|                        | < 350                           | 350 to 2000 | > 2000 |  |  |
| < 1.6                  | 260                             | 260         | 260    |  |  |
| 1.6 to 2.5             | 260                             | 250         | 245    |  |  |
| > 2.5                  | 250                             | 245         | 245    |  |  |

#### Table 15. Lead-free process (from J-STD-020C)

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 43.